ShinDengen

# ST04-33F1

**TVS**

**8.0A, 400W**

### Feature

- Peak pulse power:400W
- Small SMD
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

### OUTLINE

**Package (House Name):** 1F
**Package (JEDEC Code):** DO-214AC

### Equivalent circuit


## Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

| Item | Symbol | Conditions | Ratings | Unit |
|---|---|---|---|---|
| Storage temperature | Tstg | | -55 to 175 | ℃ |
| Operating junction temperature | Tj | | -55 to 175 | ℃ |
| Maximum surge reverse current | $I_{RSM}$ | 10/1000μs, Non-repetitive ※ | 8 | A |
| Maximum surge reverse power | $P_{RSM}$ | 10/1000μs, Non-repetitive ※ | 400 | W |
| Continuous (direct) reverse voltage | $V_{R(DC)}$ | | 25 | V |

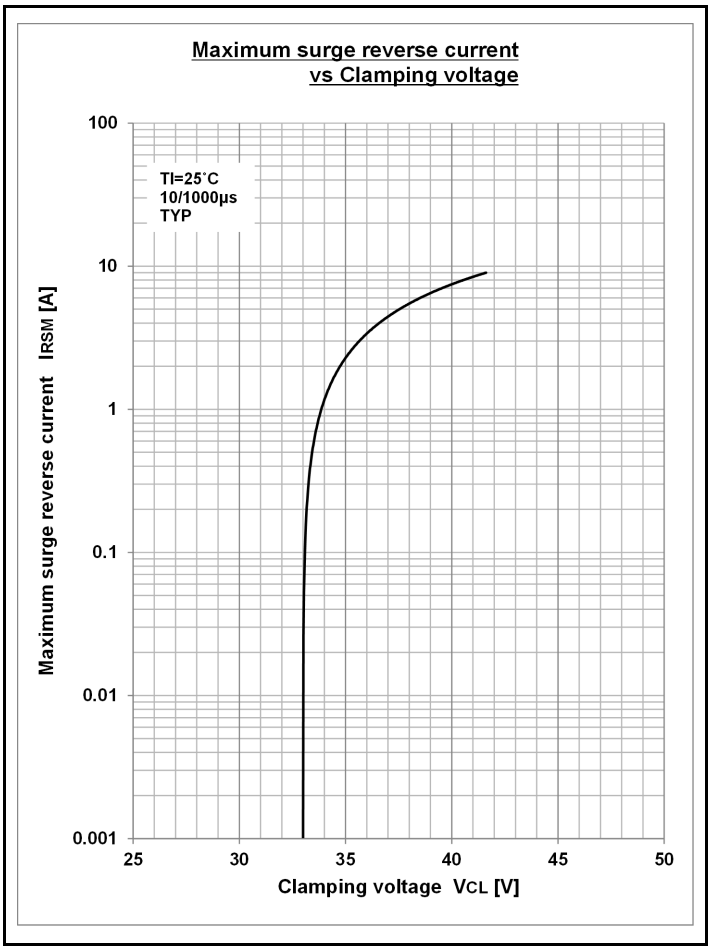
※ :See the original Specifications

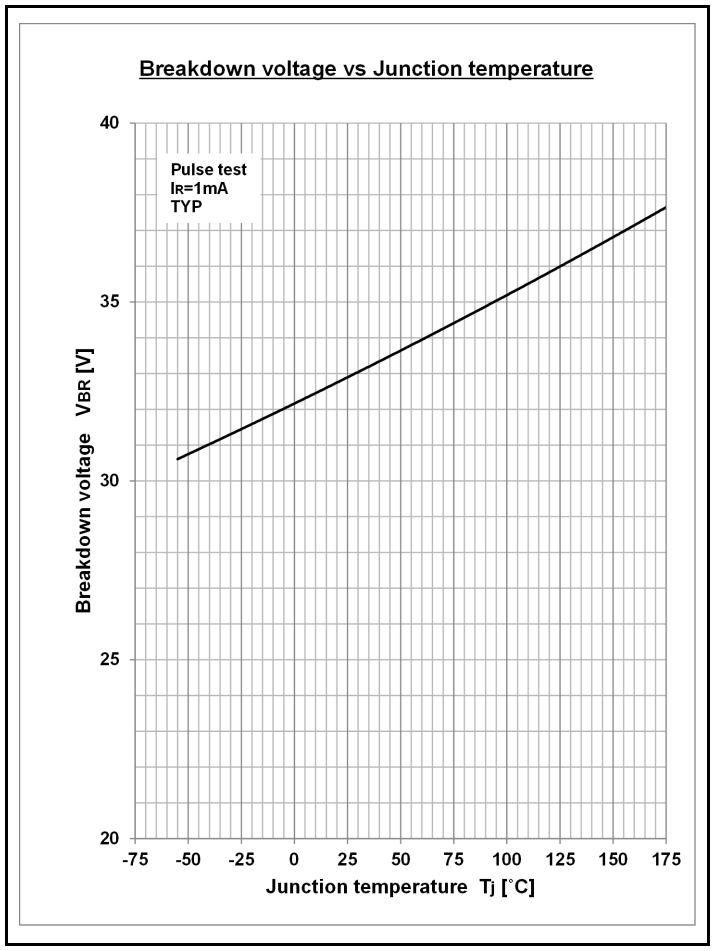
## Electrical Characteristics (unless otherwise specified : Tl=25°C)

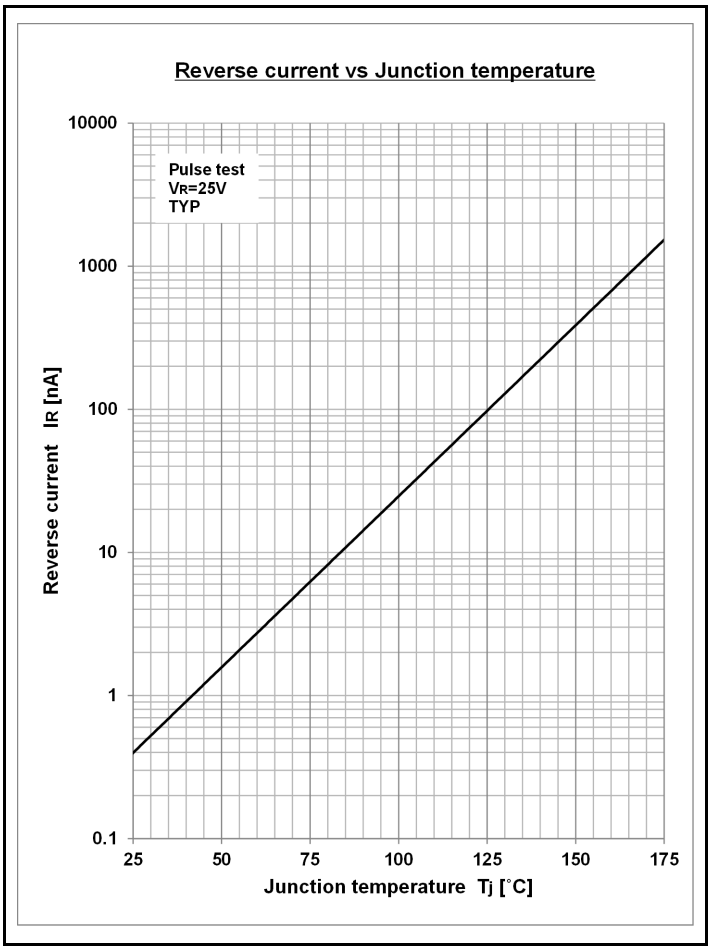
| Item | Symbol | Conditions | Ratings | | | Unit |
|---|---|---|---|---|---|---|
| | | | MIN | TYP | MAX | |
| Breakdown voltage | $V_{BR}$ | IR=1mA, Pulse measurement | 31 | | 35 | V |
| Reverse current | $I_R$ | VR=25V, Pulse measurement | | | 5 | μA |
| Electrostatic discharge capability | $V_{ESD}$ | C=330pF, R=330Ω, Polarity±, Aerial discharge ※ | | 30 | | kV |
| Thermal resistance | Rth(j-l) | Junction to lead, On glass-epoxy substrate ※ | | | 23 | ℃/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On glass-epoxy substrate ※ | | | 157 | ℃/W |

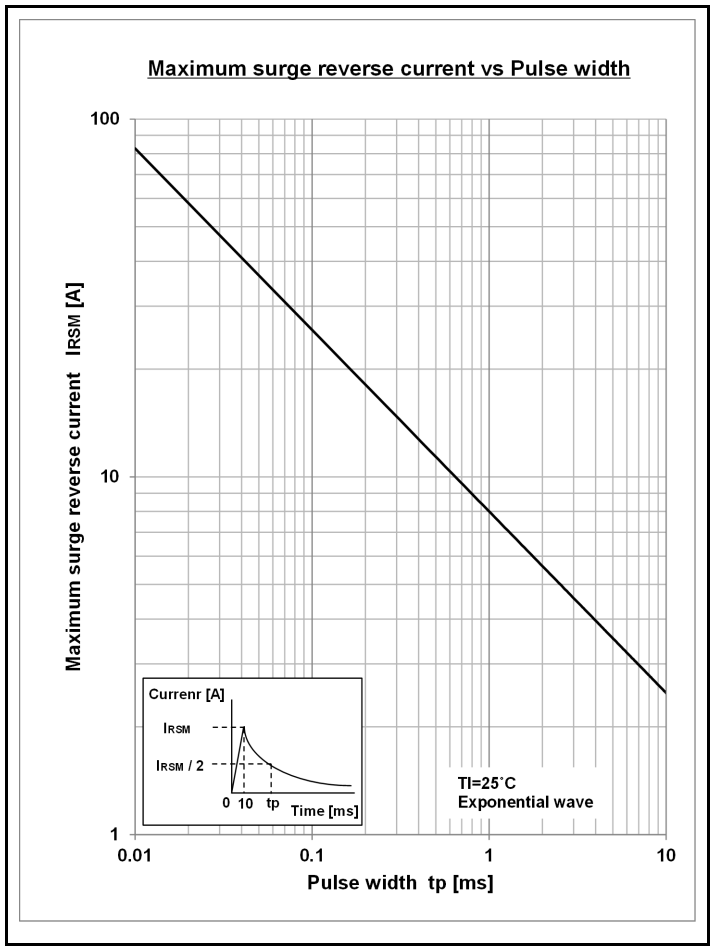
※ :See the original Specifications

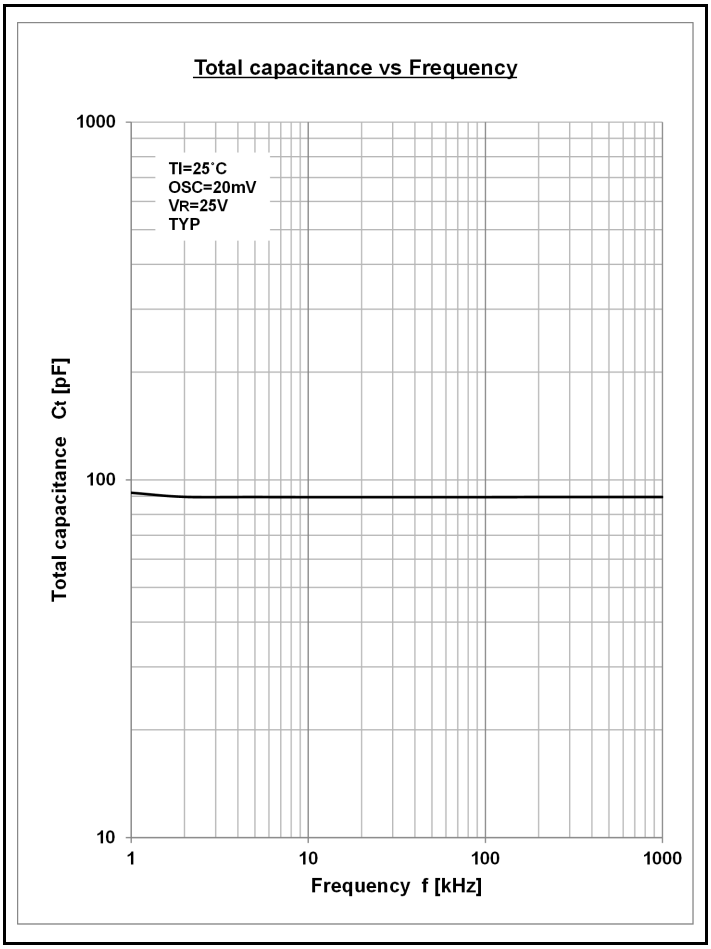
## CHARACTERISTIC DIAGRAMS

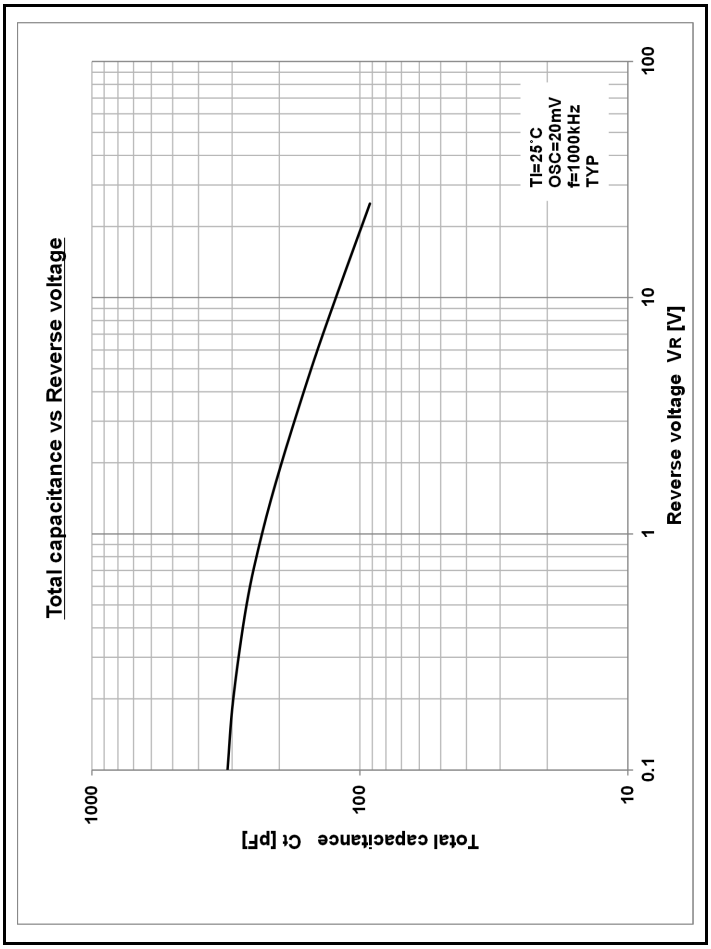


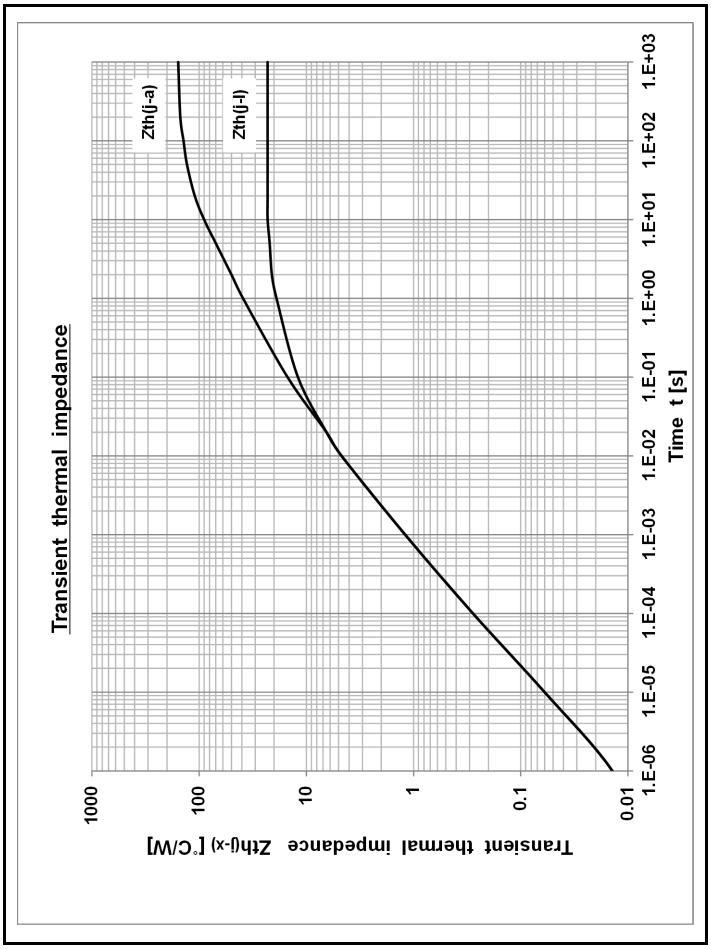




Total capacitance vs Frequency
Tl=25˚C
OSC=20mV
VR=25V
TYP
Total capacitance Ct [pF]
Frequency f [kHz]
1000
100
10
1
10
100
1000


Total capacitance vs Reverse voltage
Tl=25˚C
OSC=20mV
f=1000kHz
TYP
Total capacitance Ct [pF]
Reverse voltage VR [V]
1000
100
10
100
10
1
0.1


Transient thermal impedance
Zth(j-a)
Zth(j-l)
Transient thermal impedance Zth(j-x) [°C/W]
Time t [s]
1000
100
10
1
0.1
0.01
1.E-06
1.E-05
1.E-04
1.E-03
1.E-02
1.E-01
1.E+00
1.E+01
1.E+02
1.E+03

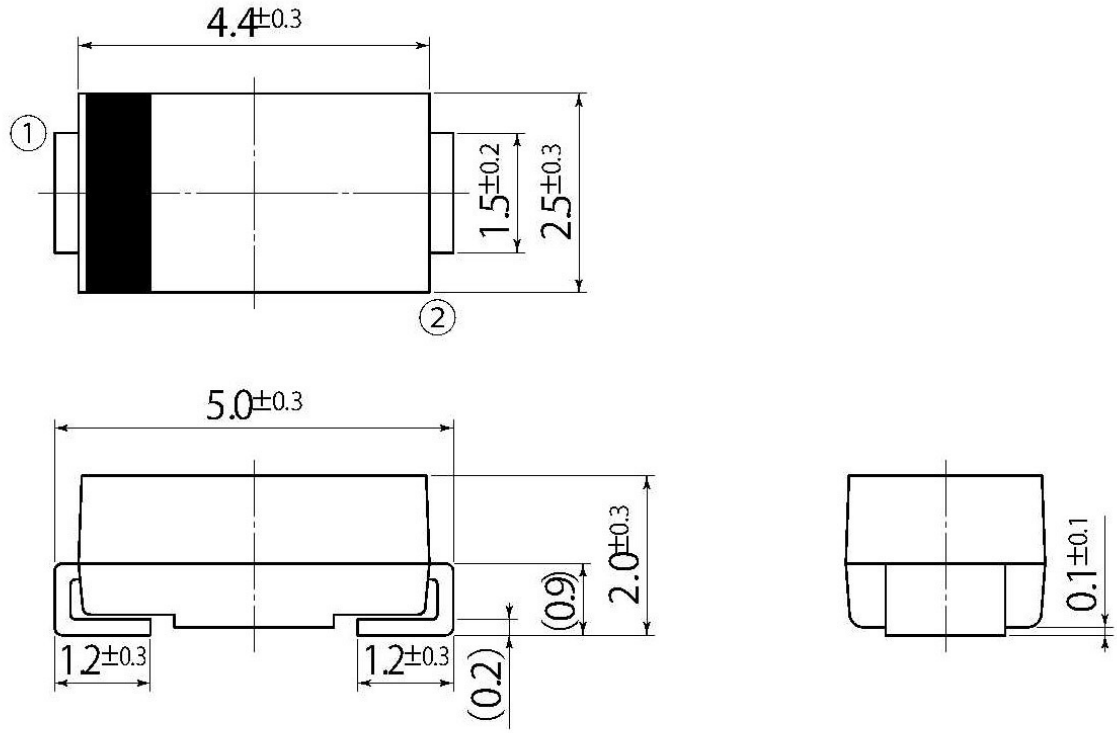
## Outline Dimensions

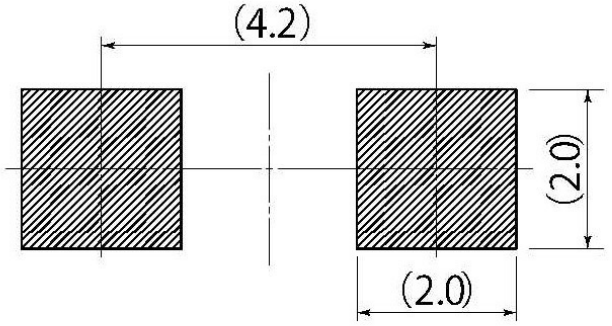
unit:mm

scale: 10/1

B3

| | |
|---|---|
| JEDEC Code | DO-214AC |
| JEITA Code | – |
| House Name | 1F |




Referential Soldering Pad

・Optimize soldering pad to the board design and soldering condition.

## Notes

1. If you wish to use any such product, please be sure to refer to the specifications issued by Shindengen.
2. All products described or contained herein are designed with a quality level intended for use in standard applications requiring an ordinary level of reliability. If these products are to be used in equipment or devices for special or specific applications requiring an extremely high grade of quality or reliability in which failures or malfunctions of products may directly affect human life or health, a local Shindengen office must be contacted in advance to confirm that the intended use of the product is appropriate. Shindengen products are grouped into the following three applications according the quality grade.

   【Standard applications】
   Computers, office automation and other office equipment, communication terminals, test and measurement equipment, audio/visual equipment, amusement equipment, consumer electronics, machine tools, personal electronic equipment, industrial equipment, etc.
   【Special applications】
   Transportation equipment (vehicles, ships, etc.), trunk-line communication equipment, traffic signal control systems, anti-disaster/crime systems, safety equipment, medical equipment, etc.
   【Specific applications】
   Nuclear reactor control systems, aircraft, aerospace equipment, submarine repeaters, life support equipment and systems, etc.
3. Although Shindengen continuously endeavors to enhance the quality and reliability of its products, customers are advised to consider and take safety measures in their design, such as redundancy, fire containment and anti-failure, so that personal injury, fires, or societal damages can be prevented.
4. Please note that all information described or contained herein is subject to change without notice due to product upgrades and other reasons. When buying Shindengen products, please contact the Company's offices or distributors to obtain the latest information.
5. Shindengen shall not bear any responsibility with regards to damages or infringement of any third-party patent rights and other intellectual property rights incurred due to the use of information on this website.
6. The information and materials on this website neither warrant the use of Shindengen's or any third party's patent rights and other intellectual property rights, nor grant license to such rights.
7. In the event that any product described or contained herein falls under the category of strategic products controlled under the Foreign Exchange and Foreign Trade Control Law of Japan, exporting of such products shall require an export license from the Japanese government in accordance with the above law.
8. No reprinting or reproduction of the materials on this website, either in whole or in part, is permitted without proper authorization from Shindengen.